



MICROCIRCUIT DATA SHEET

MJLM111-X REV 0D3

Original Creation Date: 08/18/95
Last Update Date: 11/26/01
Last Major Revision Date: 09/05/96

VOLTAGE COMPARATOR

General Description

The LM111, is a voltage comparator that has input currents nearly a thousand times lower than devices such as the LM106 and LM710. It is also designed to operate over a wider range of supply voltages: from standard $\pm 15V$ op amp supplies down to the single 5V supply used for IC logic. Its output is compatible with RTL, DTL and TTL as well as MOS circuits. Further, it can drive lamps or relays, switching voltages up to 50V at currents as high as 50mA.

Both the inputs and the outputs of the LM111, can be isolated from system ground, and the output can drive loads referred to ground, the positive supply or the negative supply. Offset balancing and strobe capability are provided and outputs can be wire OR'ed. Although slower than the LM106 and LM710 (200 ns response time vs 40ns) the devices are also much less prone to spurious oscillations. The LM111 has the same pin configuration as the LM106 and LM710.

Industry Part Number

LM111

Prime Die

LM111

NS Part Numbers

JL111BCA
JL111BGA
JL111BHA

JL111BPA
JL111SGA
JL111SHA

JL111SPA

Controlling Document

38510/10304, AMEND.1 REV E

Processing

MIL-STD-883, Method 5004

Quality Conformance Inspection

MIL-STD-883, Method 5005

Subgrp	Description	Temp (°C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55

Features

- Low Input Bias Current.
- Low Input Offset Current.
- Wide Differential Input Voltage.
- Power Supply Voltage, Single 5V to $\pm 15V$.
- Offset Voltage Null Capability.
- Strobe Capability.

(Absolute Maximum Ratings)

(Note 1)

Positive Supply Voltage	+30.0V
Negative Supply Voltage	-30.0V
Total Supply Voltage	36V
Output to Negative Supply Voltage	50V
GND to Negative Supply Voltage	30V
Differential Input Voltage	$\pm 30V$
Sink Current	50mA
Input Voltage (Note 2)	$\pm 15V$
Power Dissipation (Note 3)	
14 Ld DIP-Package	400mW at 25 C
8 Ld Metal Can-Package	330mW at 25 C
10 Ld Flatpack-Package	330mW at 25 C
8 Ld DIP-Package	400mW at 25 C
Output Short Circuit Duration	10 sec.
Maximum Strobe Current	10mA
Operating Temperature Range	-55 C to 125 C
Thermal Resistance	
Theta _{JA}	
14 Ld DIP	(Still Air @ 0.5W) 120 C/W (500LF/Min Air flow @ 0.5W) 65 C/W
8 Ld Metal Can Pkg	(Still Air @ 0.5W) 150 C/W (500LF/Min Air flow @ 0.5W) 92 C/W
10 Ld Flatpack	(Still Air @ 0.5W) 150 C/W (500LF/Min Air flow @ 0.5W) 153 C/W
8 Ld DIP	(Still Air @ 0.5W) 120 C/W (500LF/Min Air flow @ 0.5W) 76 C/W
Theta _{JC}	
14 Ld DIP	35 C/W
8 Ld Metal Can Pkg	40 C/W
10 Ld Flatpack	60 C/W
8 Ld DIP	35 C/W
Storage Temperature Range	-65 C \leq Ta \leq 150 C
Maximum Junction Temperature	175 C
Lead Temperature (Soldering, 60 seconds)	300 C
Voltage at Strobe Pin	V+ -5V
Package Weight (Typical)	
8 Ld METAL CAN	965mg
8 Ld DIP	1100mg
10 Ld FLATPACK	250mg
14 Ld DIP	TBD

(Absolute Maximum Ratings (Continued))

(Note 1)

ESD Rating
(Note 4)

300V

- Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- Note 2: This rating applies for +15V supplies. The positive input voltage limit is 30V above the negative supply. The negative input voltage limit is equal to the negative supply voltage or 30V below the positive supply, whichever is less.
- Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{jmax} (maximum junction temperature), Θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{dmax} = (T_{jmax} - T_A)/\Theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.
- Note 4: Human body model, 1.5k Ohms in series with 100pF.

Recommended Operating Conditions

Supply Voltage

 $V_{CC} = \pm 15Vdc$

Operating Temperature Range

 $-55^{\circ}C \leq T_a \leq +125^{\circ}C$

Electrical Characteristics

DC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: $\pm V_{CC} = \pm 15V$, $V_{CM} = 0V$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
V _{IO}	Input Offset Voltage	V _{in} = 0V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4	+4	mV	2, 3
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4	+4	mV	2, 3
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4	+4	mV	2, 3
V _{IO(R)}	Raised Input Offset Voltage	V _{in} = 0V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4.5	+4.5	mV	2, 3
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4.5	+4.5	mV	2, 3
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50\text{ Ohms}$			-3	+3	mV	1
					-4.5	+4.5	mV	2, 3
I _{IO}	Input Offset Current	V _{in} = 0V, $R_s = 50K\text{ Ohms}$			-10	+10	nA	1, 2
					-20	+20	nA	3
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50K\text{ Ohms}$			-10	+10	nA	1, 2
					-20	+20	nA	3
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50K\text{ Ohms}$			-10	+10	nA	1, 2
					-20	+20	nA	3
I _{IO(R)}	Raised Input Offset Current	V _{in} = 0V, $R_s = 50K\text{ Ohms}$			-25	+25	nA	1, 2
					-50	+50	nA	3
I _{IB+}	Input Bias Current	V _{in} = 0V, $R_s = 50K\text{ Ohms}$			-100	0.1	nA	1, 2
					-150	0.1	nA	3
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50K\text{ Ohms}$			-150	0.1	nA	1, 2
					-200	0.1	nA	3
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50K\text{ Ohms}$			-150	0.1	nA	1, 2
					-200	0.1	nA	3

Electrical Characteristics

DC PARAMETERS (Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: $\pm V_{CC} = \pm 15V$, $V_{CM} = 0V$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
I _{IB} -	Input Bias Current	Vin = 0V, $R_s = 50K\text{ Ohms}$			-100	0.1	nA	1, 2
					-150	0.1	nA	3
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, Vin = 0V, $V_{CM} = -14.5V$, $R_s = 50K\text{ Ohms}$			-150	0.1	nA	1, 2
					-200	0.1	nA	3
		+V _{CC} = 2V, -V _{CC} = -28V, Vin = 0V, $V_{CM} = +13V$, $R_s = 50K\text{ Ohms}$			-150	0.1	nA	1, 2
					-200	0.1	nA	3
V _{O(STB)}	Collector Output Voltage (ST)	Vin+ = Gnd, Vin- = 15V, I _{STB} = -3mA, $R_s = 50\text{ Ohms}$	1		14		V	1, 2, 3
CMR	Common Mode Rejection	-28V \leq -V _{CC} \leq -0.5V, $R_s=50\text{ Ohms}$, 2V \leq +V _{CC} \leq 29.5V, $R_s=50\text{ Ohms}$, -14.5V \leq V _{CM} \leq 13V, $R_s=50\text{ Ohms}$			80		dB	1, 2, 3
V _{OL}	Low Level Output Voltage	+V _{CC} = 4.5V, -V _{CC} = Gnd, I _{out} = 8mA, $\pm V_{in} = 0.5V$, Vid = -6mV				0.4	V	1, 2, 3
		+V _{CC} = 4.5V, -V _{CC} = Gnd, I _{out} = 8mA, $\pm V_{in} = 3V$, Vid = -6mV				0.4	V	1, 2, 3
		I _{out} = 50mA, $\pm V_{in} = 13V$, Vid = -5mV				1.5	V	1, 2, 3
		I _{out} = 50mA, $\pm V_{in} = -14V$, Vid = -5mV				1.5	V	1, 2, 3
I _{CEx}	Output Leakage Current	+V _{CC} = 18V, -V _{CC} = -18V, V _{out} = 32V			-1	10	nA	1
					-1	500	nA	2
I _i	Input Leakage Current	+V _{CC} = 18V, -V _{CC} = -18V, $+V_{in} = +12V$, $-V_{in} = -17V$	7		-5	500	nA	1, 2, 3
		+V _{CC} = 18V, -V _{CC} = -18V, $+V_{in} = -17V$, $-V_{in} = +12V$	7		-5	500	nA	1, 2, 3
I _{CC+}	Power Supply Current					6	mA	1, 2
						7	mA	3
I _{CC-}	Power Supply Current				-5		mA	1, 2
					-6		mA	3
Delta T V _{IO} /Delta T Offset Voltage	Temperature Coefficient Input Offset Voltage	25 C \leq T \leq 125 C			-25	25	uV/C	2
		-55 C \leq T \leq 25 C			-25	25	uV/C	3
Delta T I _{IO} /Delta T Offset Current	Temperature Coefficient Input Offset Current	25 C \leq T \leq 125 C			-100	100	pA/C	2
		-55 C \leq T \leq 25 C			-200	200	pA/C	3

Electrical Characteristics

DC PARAMETERS (Continued)

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: $\pm V_{CC} = \pm 15V$, $V_{CM} = 0V$

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
I _{OS}	Short Circuit Current	V _{out} = 5V, t ≤ 10mS, V _{in-} = 0.1V, V _{in+} = 0V	3, 5			200	mA	1
			3, 5			150	mA	2
			3, 5			250	mA	3
V _{IO(adj)+}	Input Offset Voltage (Adjustment)	V _{out} = 0V, V _{in} = 0V, R _S = 50 Ohms	3		5		mV	1
V _{IO(adj)-}	Input Offset Voltage (Adjustment)	V _{out} = 0V, V _{in} = 0V, R _S = 50 Ohms	3			-5	mV	1
A _{VE+}	Voltage Gain (Emitter)	R _L = 600 Ohms	3, 6		10		V/mV	4
			3, 6		8		V/mV	5, 6
A _{VE-}	Voltage Gain (Emitter)	R _L = 600 Ohms	3, 6		10		V/mV	4
			3, 6		8		V/mV	5, 6

AC PARAMETERS

(The following conditions apply to all the following parameters, unless otherwise specified.)
 AC: $\pm V_{CC} = \pm 15V$, $V_{CM} = 0$

trLHC	Response Time (Collector Output)	V _{OD(Overdrive)} = -5mV, C _L = 50pF, V _{in} = -100mV	4			300	nS	7, 8B
			4			640	nS	8A
trHLC	Response Time (Collector Output)	V _{OD(Overdrive)} = 5mV, C _L = 50pF, V _{in} = 100mV	4			300	nS	7, 8B
			4			500	nS	8A

Electrical Characteristics

DC PARAMETERS: DRIFT VALUES

(The following conditions apply to all the following parameters, unless otherwise specified.)
 DC: $\pm V_{CC} = \pm 15V$, $V_{CM} = 0V$. "Delta calculations performed on JAN S and QMLV devices at group B, subgroup 5 only".

SYMBOL	PARAMETER	CONDITIONS	NOTES	PIN-NAME	MIN	MAX	UNIT	SUB-GROUPS
V _{IO}	Input Offset Voltage	V _{in} = 0V, $R_s = 50\text{ Ohms}$			-0.5	0.5	mV	1
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50\text{ Ohms}$			-0.5	0.5	mV	1
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50\text{ Ohms}$			-0.5	0.5	mV	1
I _{IB+}	Input Bias Current	V _{in} = 0V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
I _{IB-}	Input Bias Current	V _{in} = 0V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
		+V _{CC} = 29.5V, -V _{CC} = -0.5V, V _{in} = 0V, V _{CM} = -14.5V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
		+V _{CC} = 2V, -V _{CC} = -28V, V _{in} = 0V, V _{CM} = +13V, $R_s = 50K\text{ Ohms}$			-12.5	12.5	nA	1
I _{CEx}	Output Leakage Current	+V _{CC} = 18V, -V _{CC} = -18V, V _{out} = 32V			-5	5	nA	1

Note 1: I_{STB} = -2mA at -55°C.

Note 2: Calculated parameter.

Note 3: Use DC tape for I_{OS} and V_{IO}(adj), Ave+ and Ave- as indicated in TAPE NAME section of this JRETS.

Note 4: Uses AC tape and hardware.

Note 5: Actual min. limit used is 5mA due to test setup.

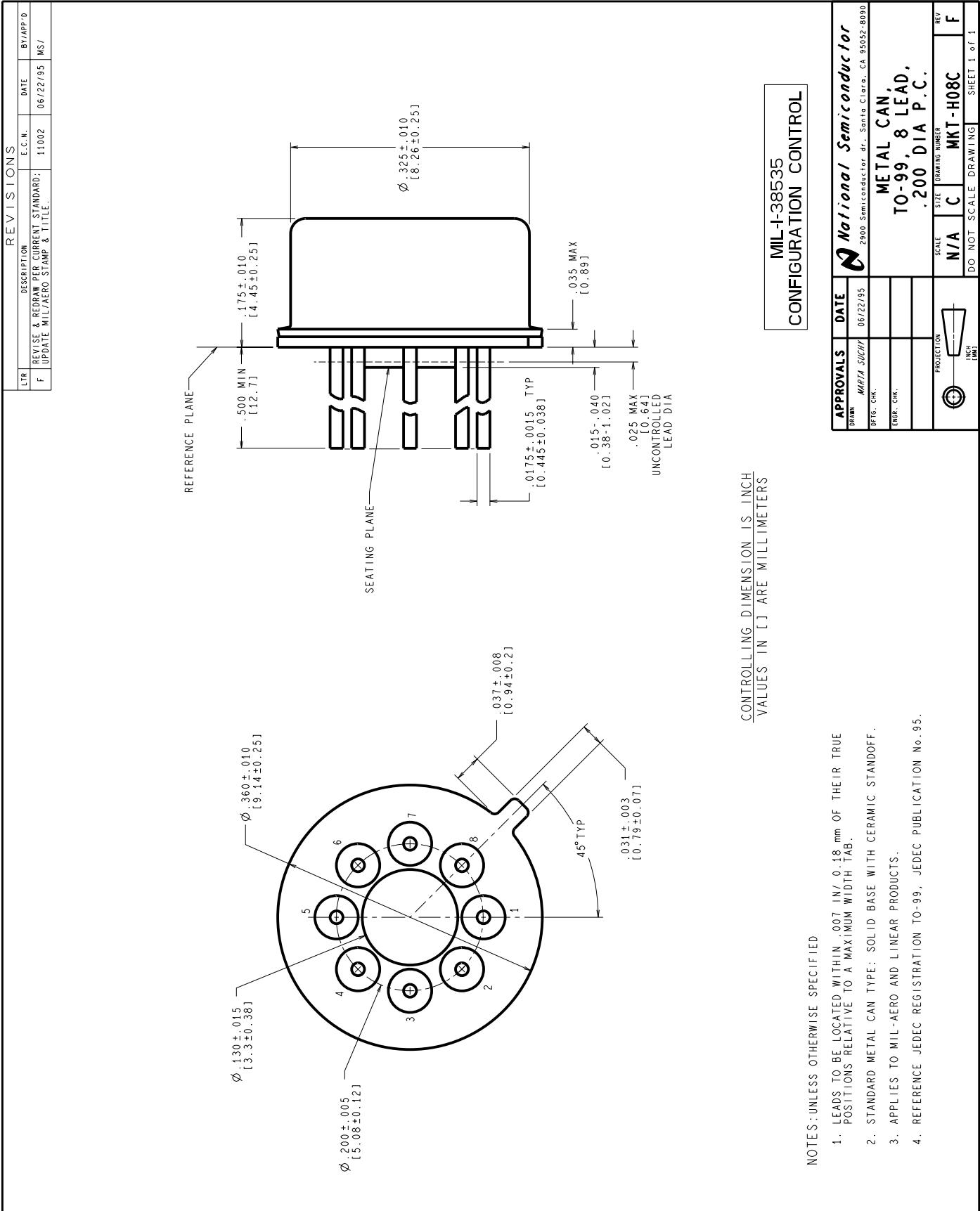
Note 6: Datalog reading in K = V/mV.

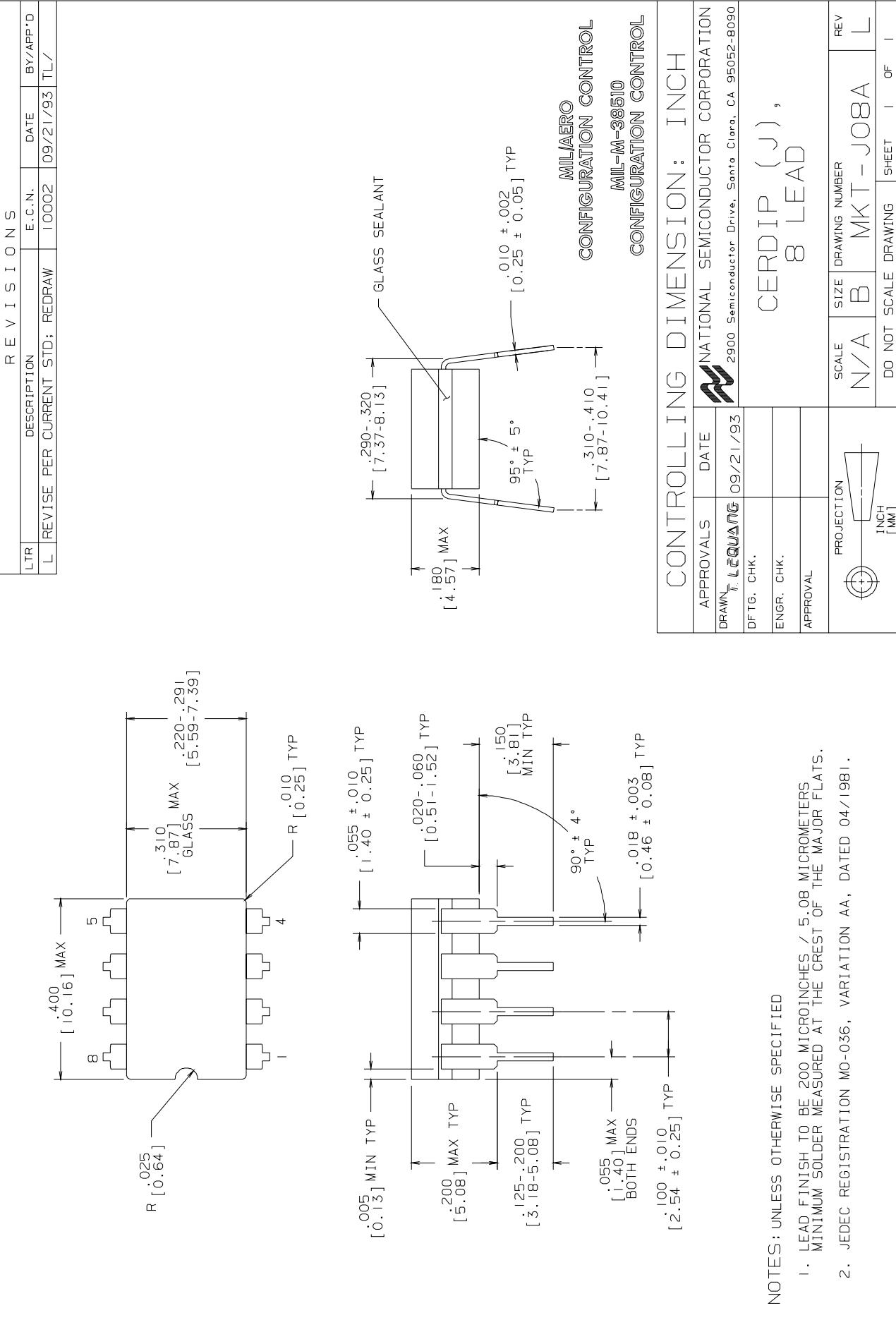
Note 7: Vid is voltage difference between inputs.

Graphics and Diagrams

GRAPHICS#	DESCRIPTION
05172HRB2	METAL CAN (H), TO-99, 8LD .200 DIA P.C. (B/I CKT)
05174HRC2	CERPACK (W), 10 LEAD (B/I CKT)
05284HRC2	METAL CAN (H), TO-99, 3LD .200 DIA P.C. (B/I CKT)
05349HRE2	CERDIP (J), 14 LEAD (B/I CKT)
05445HRC2	CERDIP (J), 8 LEAD (B/I CKT)
05652HRA2	CERDIP (J), 8 LEAD (B/I CKT)
09569HRC3	CERPACK (W), 10 LEAD (B/I CKT)
09570HRC2	CERDIP (J), 14 LEAD (B/I CKT)
H08CRF	METAL CAN (H), TO-99, 8LD, .200 DIA P.C. (P/P DWG)
J08ARL	CERDIP (J), 8 LEAD (P/P DWG)
J14ARH	CERDIP (J), 14 LEAD (P/P DWG)
P000151A	METAL CAN (H), TO-99, 8LD .200 DIA P.C.(PIN OUT)
P000152A	CERPACK (W), 10 LEAD (PIN OUT)
P000153A	CERDIP (J), 8 LEAD (PIN OUT)
P000387A	CERDIP (J), 14 LEAD (PINOUT)
W10ARG	CERPACK (W), 10 LEAD (P/P DWG)

See attached graphics following this page.





R E V I S I O N S

LTR	DESCRIPTION	E.C.N.	DATE	BY/APP'D
H	REVISE PER CURRENT STD; REDRAW	10001	09/15/93	TLL/

MIL/AERO
CONFIGURATION CONTROL **ML-M-38510**
CONFIGURATION CONTROL **CONFIGURATION CONTROL**

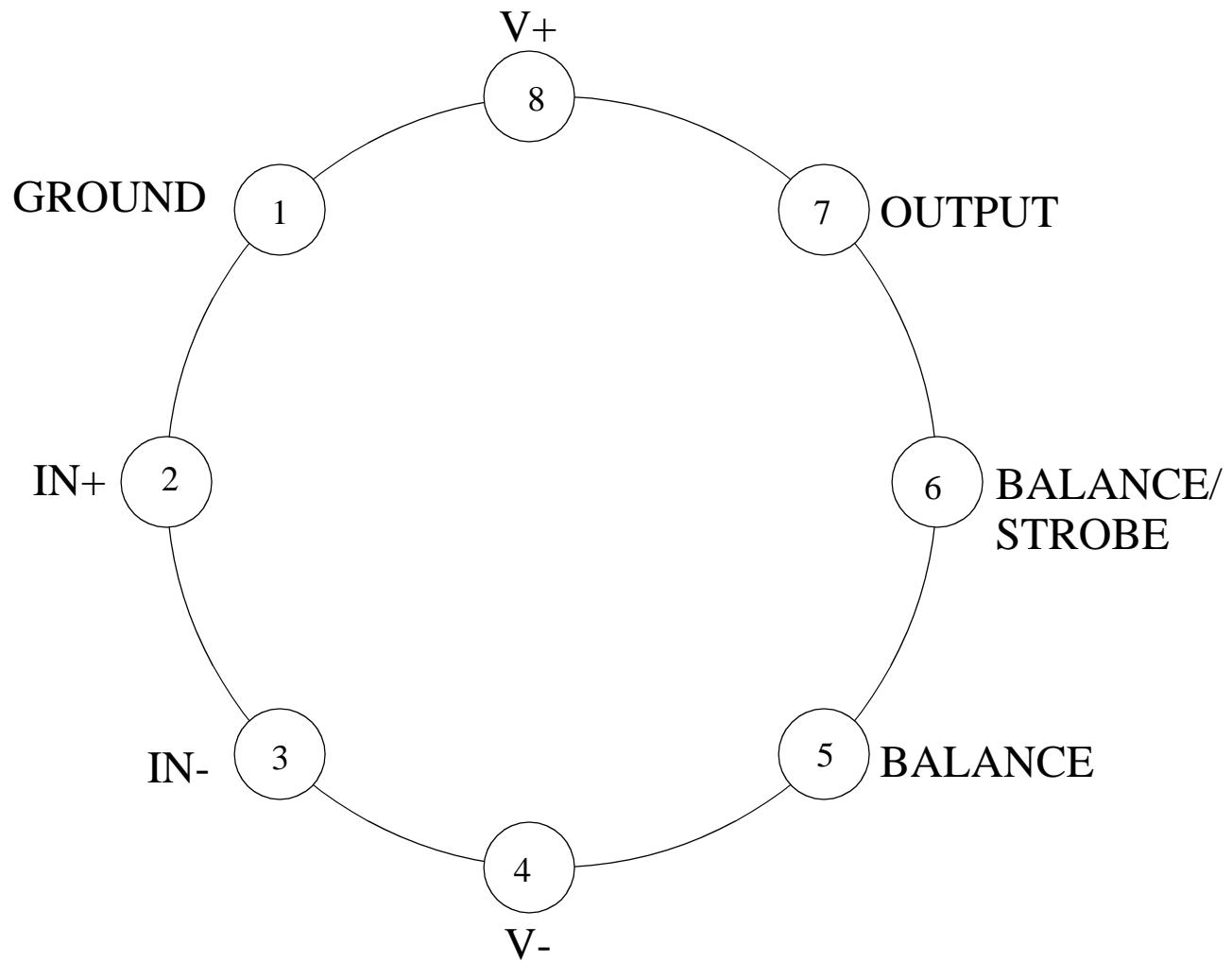
APPROVALS	DATE	NATIONAL SEMICONDUCTOR CORPORATION		
DRAWN I. L. QUANG	09/15/93	2900 Semiconductor Drive, Santa Clara, CA 95052-8090		
DF TG. CHK.				
ENGR. CHK.				
APPROVAL				

CONTROLLING DIMENSION: INCH

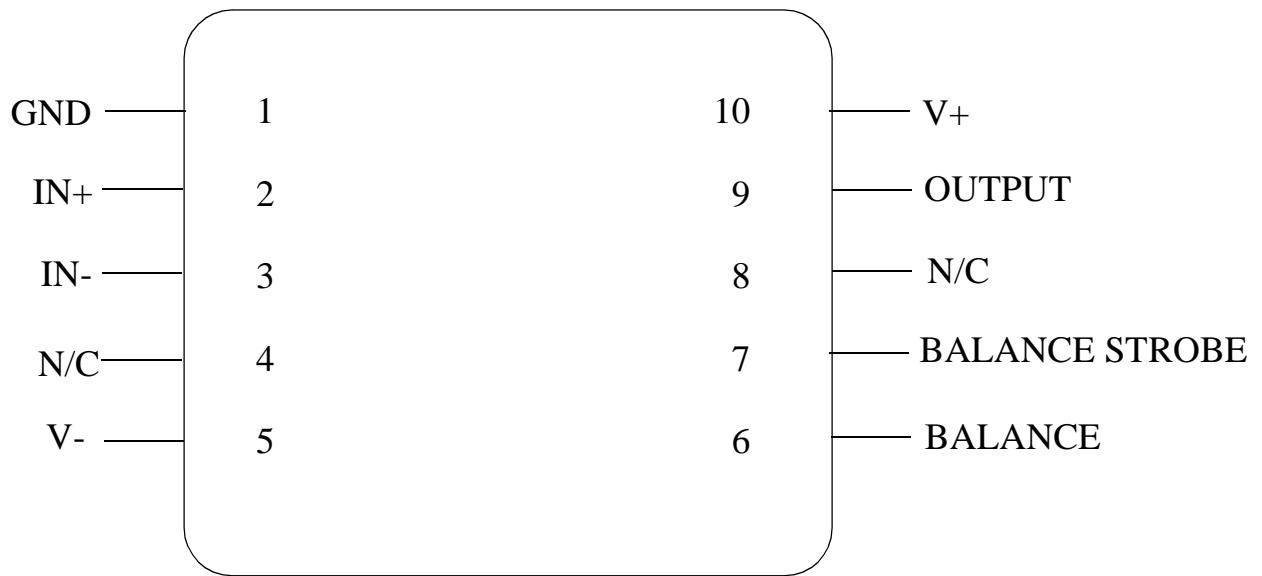
NOTES: UNLESS OTHERWISE SPECIFIED

- LEAD FINISH TO BE 200 MICROINCHES / 5.08 MICROMETERS
MINIMUM SOLDER MEASURED AT THE CREST OF THE MAJOR FLATS.
- JEDEC REGISTRATION MO-036, VARIATION AB, DATED 04/1981.

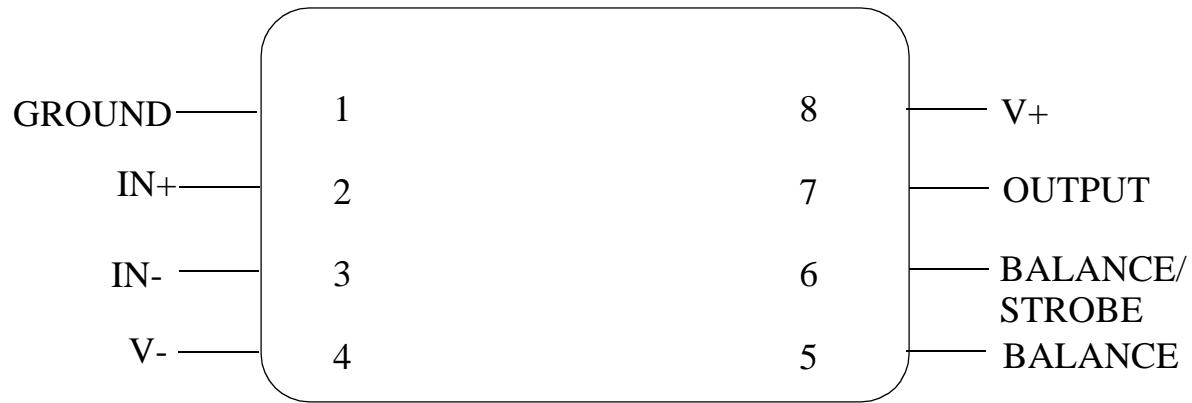
PROJECTION SCALE SIZE DRAWING NUMBER
DO NOT SCALE DRAWING SHEET REV
INCH MM J-14A H
1 OF 1



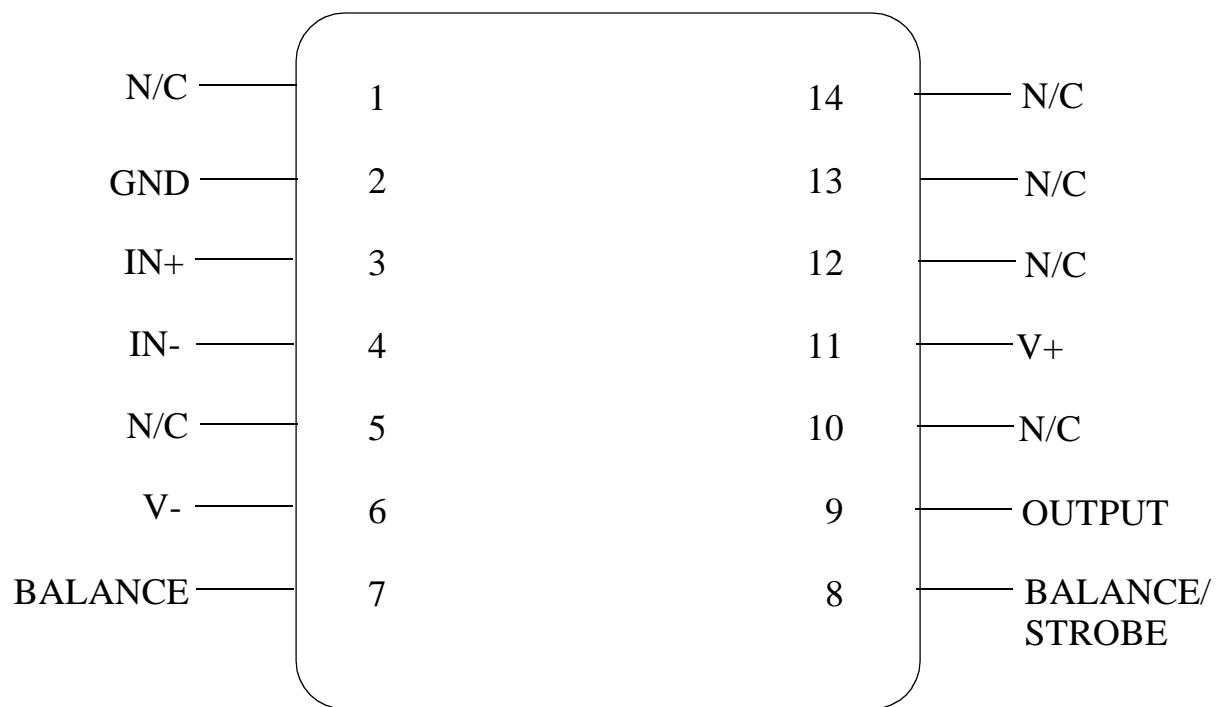
JL111H
8 - PIN METAL CAN
CONNECTION DIAGRAM
TOP VIEW
P000151A



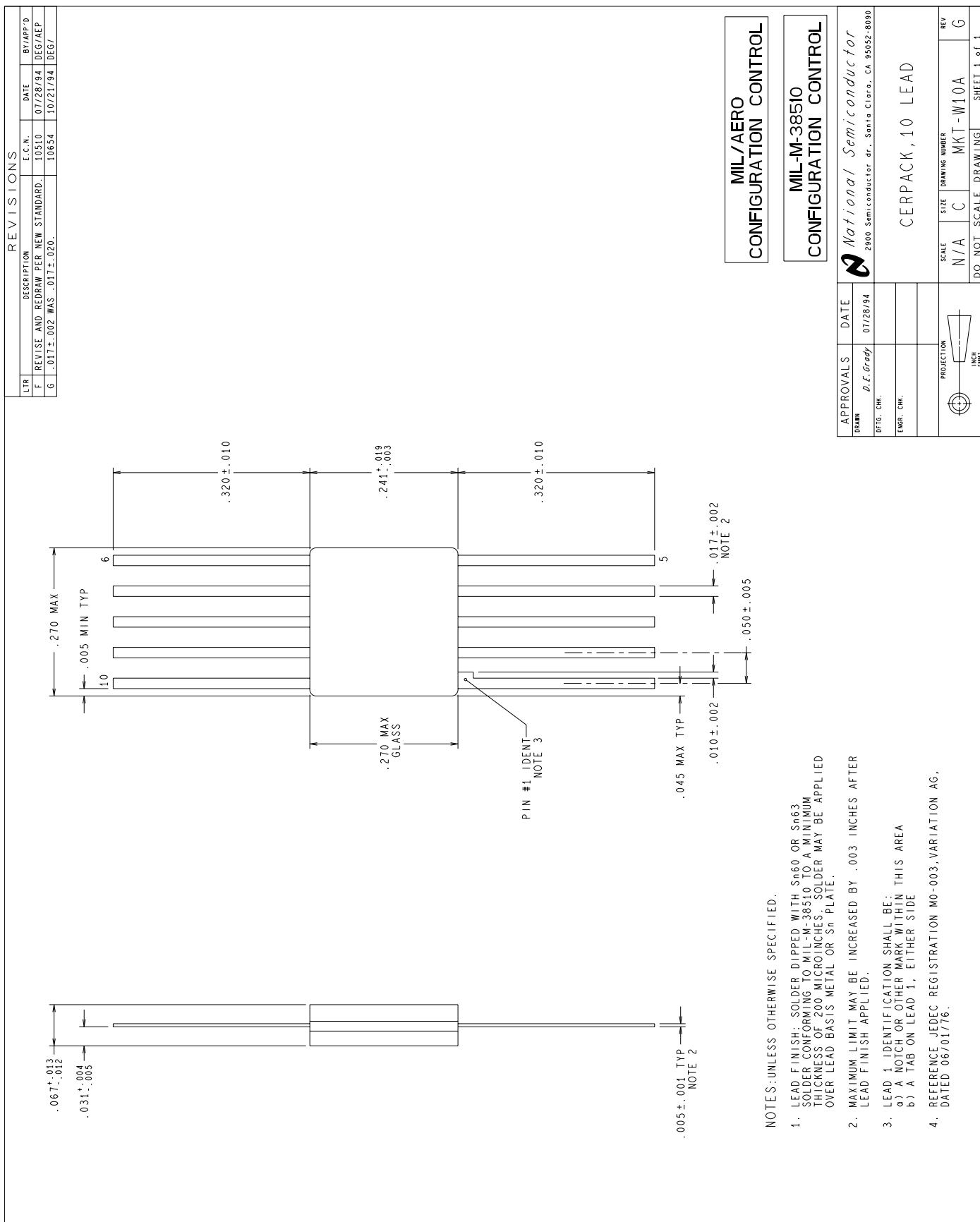
JL111W
10 - LEAD CERPACk
CONNECTION DIAGRAM
TOP VIEW
P000152A



JL111J-8
8 - LEAD DIP
CONNECTION DIAGRAM
TOP VIEW
P000153A



JL111J
14 - LEAD DIP
CONNECTION DIAGRAM
TOP VIEW
P000387A



Revision History

Rev	ECN #	Rel Date	Originator	Changes
0C1	M0003013	07/11/01	Rose Malone	Update MDS: MJLM111-X Rev. 0B0 to MJLM111-X Rev. 0C1. Updated Power Dissipation Condition, Added Thermal Data and Burn-In Ckts for all packages. Changed Pinout P000150A to P000387A to match Data Base.
0D1	M0003219	08/13/01	Rose Malone	Updated MDS: MJLM111-X, Rev. 0C1 to MJLM111-X, Rev. 0D1. corrected typo on reference to B/I Ckt, from 05445HRC to 05445HRC1, Per SG's request.
0D2	M0003830	11/2/01	Rose Malone	Update MDS: MJLM111-X, Rev. 0D1 to MJLM111-X, Rev. 0D2. Updated Graphics Section B/I Ckt. from 05545HRC1 to 05545HRC2.
0D3	M0003940	11/26/01	Rose Malone	Update MDS: MJLM111-X, Rev. 0D2 to MJLM111-X, Rev. 0D3. Changes made to graphics section, B/I CKT revision 09569HRC2 to 09569HRC3. Typo in previous Revision History Section regarding B/I CKT should have reflected B/I CKT 05445HRC2